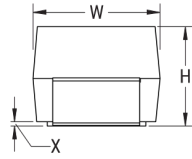


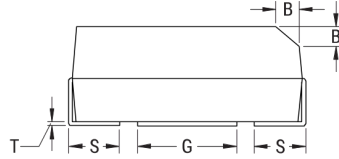
## T493B335K020CH6120

T493 HRA, Tantalum, MnO<sub>2</sub> Tantalum, HRA, 3.3 uF, 10%, 20 VDC, SMD, MnO<sub>2</sub>, Molded, High Reliability, C (0.01%/1000 Hrs), 1.3 Ohms, 3528, Height Max = 2.1mm

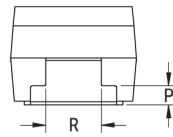
CATHODE (-) END VIEW



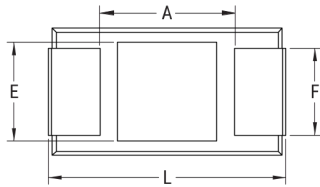
SIDE VIEW



ANODE (+) END VIEW



BOTTOM VIEW



Click [here](#) for the 3D model.

### General Information

Series	T493 HRA
Dielectric	MnO <sub>2</sub> Tantalum
Style	SMD Chip
Description	SMD, MnO <sub>2</sub> , Molded, High Reliability
Features	High Reliability
RoHS	No
Prop 65	<b>⚠ WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">http://www.p65warnings.ca.gov</a> .
SCIP Number	1dd2e1b8-26dd-4d52-927c-6f9d519011aa
Termination	Solder Coated
AEC-Q200	No
Component Weight	102.3 mg
Notes	P and R dimensions represents the minimum solderable area of the termination surface entirely below cutout (if one is present).

### Dimensions

Footprint	3528
L	3.5mm +/-0.2mm
W	2.8mm +/-0.2mm
H	1.9mm +/-0.2mm
T	0.13mm REF
S	0.8mm +/-0.3mm
F	2.2mm +/-0.1mm
A	1.9mm MIN
B	0.4mm +/-0.15mm
E	2.2mm REF
G	1.8mm REF
P	0.35mm MIN
R	1mm REF
X	0.1mm +/-0.1mm

### Specifications

Capacitance	3.3 uF
Capacitance Tolerance	10%
Voltage DC	20 VDC (85C), 13.4 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6% 120Hz 25C
Failure Rate	C (0.01%/1000 Hrs)
Resistance	1.3 Ohms (100kHz 25C)
Ripple Current	240 mA (rms, 100kHz 25C)
Leakage Current	0.7 uA (5min 25°C)
Testing and Reliability	Standard Testing Only

### Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	2000

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.